

THB Grade IIIB Class Y2 Interference Suppression Film Capacitor Radial MKP 305 V_{AC} - Line Bypass



FEATURES

- IEC 60384-14: 2013 / AMD1: 2016 grade IIIB: 85 °C, 85 % RH, 1000 h at U_{RAC}
- AEC-Q200 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT

APPLICATIONS

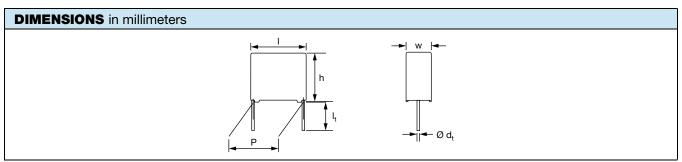
For standard line bypass (between line and ground) Y2 applications.

See also application note: www.vishay.com/doc?28153

| QUICK REFERENCE DATA | |
|---|--|
| Rated capacitance range | 0.01 μF to 1 μF (preferred values according to E6) |
| Capacitance tolerance | ± 20 %; ± 10 %; ± 5 % (37.5 mm ± 5 % pitch values on request) |
| Climatic testing class according to IEC 60068-1 | 55 / 105 / 56B |
| Rated DC voltage | 1000 V _{DC} |
| Permissible AC voltage | 305 V _{AC} ; 50 Hz to 60 Hz |
| Maximum application temperature | 105 °C |
| Reference standards | IEC 60384-14:2013 IEC 60384-14:2013 / AMD1:2016 EN 60384-14 IEC 60065 requires pass. flamm. class B for volume ≥ 1750 mm ³ Class C for volume < 1750 mm ³ UL 60384-14 (2 nd edition) CSA-E60384-1:14 (3 rd edition) CQC |
| Dielectric | Polypropylene film |
| Electrodes | Metallized |
| Construction | Series construction |
| Encapsulation | Plastic case, epoxy resin sealed, flame retardant UL-class 94 V-0 |
| Leads | Tinned wire |
| Marking | C-value; tolerance; rated voltage; sub-class; manufacturer's type; code for dielectric material; manufacturer location, manufacturer's logo, year and week; safety approvals |

Note

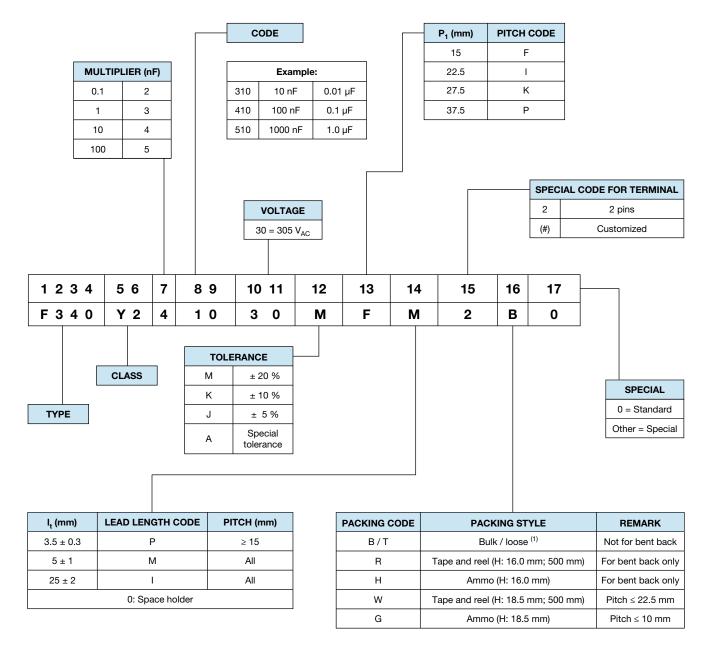
• For more detailed data and test requirements, contact rfi@vishay.com



- Standard dimension
- Ø $d_t \pm 10$ % of standard diameter specified



COMPOSITION OF CATALOG NUMBER



- For detailed tape specifications refer to packaging information www.vishay.com/doc?28139
- (1) Packaging will be bulk for all capacitors with pitch ≤ 15 mm and such with long leads (> 5 mm). Capacitors with short leads up to 5 mm and pitch > 15 mm will be in tray and asking code will be "T"



| SPECIFIC REFERENCE DATA | | | | | |
|---|-------------------------|-------------------------|--|--|--|
| DESCRIPTION | VA | LUE | | | |
| Rated AC voltage (U _{RAC}) | 30 | 5 V | | | |
| Permissible DC voltage (U _{RDC}) | 100 | 00 V | | | |
| Tangent of loss angle | At 1 kHz | At 10 kHz | | | |
| | ≤ 10 x 10 ⁻⁴ | ≤ 20 x 10 ⁻⁴ | | | |
| Rated voltage pulse slope (du/dt) _R at 420 V _{DC} | 100 | V/µs | | | |
| R between leads, for C ≤ 0.33 μF at 100 V; 1 min | > 15 0 | 00 ΜΩ | | | |
| RC between leads, for C > 0.33 µF at 100 V; 1 min | > 50 | 000 s | | | |
| R between leads and case; 100 V; 1 min $>$ 30 000 M Ω | | | | | |
| Withstanding (DC) voltage (cut off current 10 mA) (1); rise time ≤ 1000 V/s | 3400 V; 1 min | | | | |
| Withstanding (AC) voltage between leads and case | 2100 \ | /; 1 min | | | |

Note

⁽¹⁾ See "Voltage Proof Test for Metalized Film Capacitors": www.vishay.com/doc?28169

| ELE | CTRIC | AL DATA AND | ORDEF | RING INFORM | MATION | | | | | |
|-------------------------|--------------|--------------------|----------------------------|-------------------------------------|-------------------------------------|--------|--------------------------------------|-------|--|------|
| | | | | | CATALOG NU | MBER | F340Y2 AND P | ACKAC | GING | |
| ١ | | DIMENSIONS (4) | | | LOOSE IN | вох | | | TAPED REE | L |
| U _{RAC} (V) | CAP. (µF) | wxhxl | MASS (g) ⁽³⁾ | SHO | ORT LEADS | | LONG LEA | os | (500 mm) ⁽¹⁾ | (2) |
| () | u , | (mm) | (5) | l _t = 3.5 mm ± 0.3 mm | l _t = 5.0 mm ± 1.0 mm | SPQ | l _t = 25.0 mm ± 2.0 mm | SPQ | H = 18.5 mm; P ₀ = 12.7 mm | SPQ |
| | | | PITCH = ' | 15.0 mm ± 0.4 mn | n; d _t = 0.60 mm ± | 0.06 m | m; C-TOL. = ± 20 |) % | | |
| | 0.01 | | | 31030MFP2B0 | 31030MFM2B0 | | 31030MFI2B0 | | 31030MF02W0 | |
| | 0.012 | 5.0 x 11.0 x 17.5 | 1.0 | 31230MFP2B0 | 31230MFM2B0 | 1250 | 31230MFI2B0 | 1000 | 31230MF02W0 | 1100 |
| | 0.015 | 5.0 X 11.0 X 17.5 | 1.0 | 31530MFP2B0 | 31530MFM2B0 | 1250 | 31530MFI2B0 | 1000 | 31530MF02W0 | 1100 |
| | 0.018 | | | 31830MFP2B0 | 31830MFM2B0 | | 31830MFI2B0 | | 31830MF02W0 | |
| | 0.022 | 6.0 x 11.0 x 17.5 | 1.4 | 32230MFP2B0 | 32230MFM2B0 | 1000 | 32230MFI2B0 | 1000 | 32230MF02W0 | 900 |
| | | | PITCH = | 15.0 mm ± 0.4 mr | n; d _t = 0.80 mm ± | 0.08 m | m; C-TOL. = ± 20 |) % | | |
| | 0.027 | | | 32730MFP2B0 | 32730MFM2B0 | | 32730MFI2B0 | | 32730MF02W0 | |
| | 0.033 | 7.0 x 13.5 x 17.5 | 1.8 | 33330MFP2B0 | 33330MFM2B0 | 750 | 33330MFI2B0 | 500 | 33330MF02W0 | 800 |
| | 0.039 | | | 33930MFP2B0 | 33930MFM2B0 | | 33930MFI2B0 | | 33930MF02W0 | |
| | 0.047 | 05 450 475 | 0.4 | 34730MFP2B0 | 34730MFM2B0 | 750 | 34730MFI2B0 | 500 | 34730MF02W0 35630MF02W0 | 050 |
| | 0.056 | 8.5 x 15.0 x 17.5 | 2.4 | 35630MFP2B0 | 35630MFM2B0 | 750 | 35630MFI2B0 | 500 | | 650 |
| | 0.068 | 10.0 x 16.5 x 17.5 | 3.0 | 36830MFP2B0 | 36830MFM2B0 | 500 | 36830MFI2B0 | 450 | 36830MF02W0 | 600 |
| | 0.082 | 10.5 x 17.5 x 18.0 | 4.5 | 38230MFP2B0 | 38230MFM2B0 | 250 | 38230MFI2B0 | 400 | - | |
| 305 | | | PITCH = 2 | 22.5 mm ± 0.4 mr | n; d _t = 0.80 mm ± | 0.08 m | m; C-TOL. = ± 20 |) % | | |
| | 0.033 | | | 33330MIP2T0 | 33330MIM2T0 | | 33330MII2B0 | | | |
| | 0.039 | 6.0 x 15.5 x 26.0 | 2.4 | 33930MIP2T0 | 33930MIM2T0 | 300 | 33930MII2B0 | 250 | | |
| | 0.047 | | | 34730MIP2T0 | 34730MIM2T0 | | 34730MII2B0 | | | |
| | 0.056 | 7.0 x 16.5 x 26.0 | 2.9 | 35630MIP2T0 | 35630MIM2T0 | 200 | 35630MII2B0 | 250 | | |
| | 0.068 | 7.0 X 10.3 X 20.0 | 2.9 | 36830MIP2T0 | 36830MIM2T0 | 200 | 36830MII2B0 | 230 | | |
| | 0.082 | 8.5 x 18.0 x 26.0 | 3.8 | 38230MIP2T0 | 38230MIM2T0 | 200 | 38230MII2B0 | 250 | | |
| | 0.10 | 0.0 X 10.0 X 20.0 | 0.0 | 41030MIP2T0 | 41030MIM2T0 | 200 | 41030MII2B0 | 200 | _ | |
| | 0.12 | 10.0 x 19.5 x 26.0 | 6.8 | 41230MIP2T0 | 41230MIM2T0 | 200 | 41230MII2B0 | 200 | | |
| | 0.15 | 10.0 X 10.0 X 20.0 | 0.0 | 41530MIP2T0 | 41530MIM2T0 | 200 | 41530MII2B0 | 200 | | |
| | 0.18 | 12.0 x 22.0 x 26.0 | 7.8 | 41830MIP2T0 | 41830MIM2T0 | 150 | 41830MII2B0 | 200 | | |
| | 0.22 | 12.5 % 22.5 % 20.0 | 7.0 | 42230MIP2T0 | 42230MIM2T0 | 100 | 42230MII2B0 | 200 | | |
| | 0.27 | | | 42730MIP2T0 | 42730MIM2T0 | | 42730MII2B0 | | | |
| | 0.33 | 15.5 x 26.5 x 26.5 | 14 | 43330MIP2T0 | 43330MIM2T0 | 110 | 43330MII2B0 | 275 | | |
| | 0.39 | | | 43930MIP2T0 | 43930MIM2T0 | | 43930MII2B0 | | | |

- SPQ = Standard Packing Quantity
- (1) Reel diameter = 356 mm is available on request
- (2) H = in-tape height; $P_0 = \text{sprocket hole distance}$; for detailed specifications refer to "Packaging Information"
- (3) Weight for short lead product only
- (4) For tolerances see chapter "Space Requirements for Printed-Circuit Board Applications and Dimension Tolerances"



Vishay BCcomponents

| ELE | CTRIC | AL DATA AND | ORDEF | RING INFORM | IATION | | | | | |
|-------------------------|----------------|--------------------|----------------------------|-------------------------------------|---|----------|--------------------------------------|-------------|--|--------|
| | | | | | CATALOG NU | MBER | F340Y2 AND P | ACKAG | ING | |
| | DIMENSIONS (4) | | | | LOOSE IN | вох | | | TAPED REE | : : |
| U _{RAC} (V) | CAP. (µF) | wxhxl | MASS (g) ⁽³⁾ | SHO | ORT LEADS | | LONG LEA | os | (500 mm) ⁽¹⁾ | |
| (0) | (μΓ) | (mm) | (9) | I _t = 3.5 mm ± 0.3 mm | l _t = 5.0 mm ± 1.0 mm | SPQ | l _t = 25.0 mm ± 2.0 mm | SPQ | H = 18.5 mm; P ₀ = 12.7 mm | SPQ |
| | | | DITCH (| | - | 0.00 | | 2.0/ | P ₀ = 12.7 111111 | |
| | 0.10 | | PIICH = 4 | | n; d _t = 0.80 mm ± | U.U6 III | | J % | | |
| | 0.10 | 9.0 x 19.0 x 31.0 | 5.5 | 41030MKP2T0 | 41030MKM2T0 | 100 | 41030MKI2B0 | 150 | | |
| | 0.12 0.15 | | | 41230MKP2T0 41530MKP2T0 | 41230MKM2T0 41530MKM2T0 | | 41230MKI2B0 41530MKI2B0 | | | |
| | 0.13 | 11.0 x 21.0 x 31.0 | 7.4 | 41830MKP2T0 | 41830MKM2T0 | 100 | 41830MKI2B0 | 125 | | |
| | 0.18 | | | 42230MKP2T0 | 42230MKM2T0 | | | | | |
| | 0.22 | 13.0 x 23.0 x 31.0 | 9.2 | | | 100 | 42230MKI2B0 | 125 | | |
| | | 15.005.001.0 | 10.0 | 42730MKP2T0 | 42730MKM2T0 | 100 | 42730MKI2B0 | 105 | - | |
| | 0.33 | 15.0 x 25.0 x 31.0 | 12.3 | 43330MKP2T0 | 43330MKM2T0 | 100 | 43330MKI2B0 | 125 | | |
| | 0.39 | 18.0 x 28.0 x 31.0 | 16.1 | 43930MKP2T0 | 43930MKM2T0 | 100 | 43930MKI2B0 | 100 | | |
| | 0.47 | | | 44730MKP2T0 | 44730MKM2T0 | | 44730MKI2B0 | | | |
| | 0.56 | 21.0 x 31.0 x 31.0 | 20.3 | 45630MKP2T0 | 45630MKM2T0 | 50 | 45630MKI2B0 | 75 | | |
| | 0.68 | | | 46830MKP2T0 | 46830MKM2T0 | | 46830MKI2B0 | | | |
| | 0.82 | 20.0 x 35.0 x 31.0 | 17.5 | 48230MKP2T0 | 48230MKM2T0 | 50 | 48230MKI2B0 | 75 | | |
| | | | | | m; d _t = 1.0 mm ± | | - | | | |
| | 0.47 | 14.5 x 24.5 x 41.5 | 15.5 | 44730MPP2T0 | 44730MPM2T0 | 80 | 44730MPI2T0 | 80 | | |
| | 0.68 | 16.0 x 28.5 x 41.5 | 19.5 | 46830MPP2T0 | 46830MPM2T0 | 70 | 46830MPI2T0 | 70 | = | |
| | 1.0 | 18.0 x 32.5 x 41.5 | 25 | 51030MPP2T0 | 51030MPM2T0 | 60 | 51030MPI2T0 | 60 | | |
| | | | PITCH = 1 | | n; d _t = 0.60 mm ± | 0.06 m | |) % | | |
| | 0.010 | | | 31030KFP2B0 | 31030KFM2B0 | | 31030KFI2B0 | 1000 | 31030KF02W0 | |
| | 0.012 | 5.0 x 11.0 x 17.5 | 1.0 | 31230KFP2B0 | 31230KFM2B0 | 1250 | 31230KFI2B0 | | 31230KF02W0 | 1100 |
| | 0.015 | | | 31530KFP2B0 | 31530KFM2B0 | | 31530KFI2B0 | | 31530KF02W0 | |
| 305 | 0.018 | | | 31830KFP2B0 | 31830KFM2B0 | | 31830KFI2B0 | | 31830KF02W0 | |
| 000 | 0.022 | 6.0 x 12.0 x 17.5 | 1.4 | 32230KFP2B0 | 32230KFM2B0 | 1000 | 32230KFI2B0 | 1000 | 32230KF02W0 | 900 |
| | 0.007 | | PIICH = ' | | n; d _t = 0.80 mm ± | 0.08 m | |) % | 007001/50014/0 | |
| | 0.027 | 7.0 x 13.5 x 17.5 | 1.8 | 32730KFP2B0 | 32730KFM2B0 | 750 | 32730KFI2B0 | 500 | 32730KF02W0 | 800 |
| | 0.033 | | | 33330KFP2B0 | 33330KFM2B0 | | 33330KFI2B0 | | 33330KF02W0 | |
| | 0.039 | 8.5 x 15.0 x 17.5 | 2.4 | 33930KFP2B0 | 33930KFM2B0 | 750 | 33930KFI2B0 | 500 | 33930KF02W0 | 650 |
| | 0.047 | | | 34730KFP2B0 | 34730KFM2B0 | | 34730KFI2B0 | | 34730KF02W0 | |
| | 0.056 0.068 | 10.0 x 16.5 x 17.5 | 3.0 | 35630KFP2B0 36830KFP2B0 | 35630KFM2B0 36830KFM2B0 | 500 | 35630KFI2B0 36830KFI2B0 | 450 | 35630KF02W0 36830KF02W0 | 600 |
| | | 10 5 × 17 5 × 10 0 | 4.5 | 38230KFP2B0 | | 250 | | 400 | 3003UNFU2VVU | |
| | 0.082 | 10.5 x 17.5 x 18.0 | | | 38230KFM2B0 n; d _t = 0.80 mm ± | | 38230KFI2B0 | | - | |
| | 0.033 | | | 33330KIP2T0 | 33330KIM2T0 | 0.06 111 | 33330KFI2B0 | <i>)</i> /0 | | |
| | 0.039 | 6.0 x 15.5 x 26.0 | 2.4 | 33930KIP2T0 | 33930KIM2T0 | 300 | 33930KFI2B0 | 250 | | |
| | 0.039 | 6.0 X 15.5 X 26.0 | 2.4 | 34730KIP2T0 | 34730KIM2T0 | 300 | 34730KFI2B0 | 230 | | |
| | 0.047 | 7.0 x 16.5 x 26.0 | 2.9 | 35630KIP2T0 | 35630KIM2T0 | 200 | 35630KFI2B0 | 250 | | |
| | 0.068 | 7.0 X 10.3 X 20.0 | 2.3 | 36830KIP2T0 | 36830KIM2T0 | 200 | 36830KFI2B0 | 230 | | |
| | 0.082 | 8.5 x 18.0 x 26.0 | 3.8 | 38230KIP2T0 | 38230KIM2T0 | 200 | 38230KFI2B0 | 250 | | |
| | 0.002 | 0.5 X 10.0 X 20.0 | 3.0 | 41030KIP2T0 | 41030KIM2T0 | 200 | 41030KFI2B0 | 230 | | |
| | 0.10 | 10.0 x 19.5 x 26.0 | 6.8 | 41230KIP2T0 | 41230KIM2T0 | 200 | 41230KFI2B0 | 200 | - | - |
| | 0.12 | 10.0 X 10.0 X 20.0 | 0.0 | 41530KIP2T0 | 41530KIM2T0 | 200 | 41530KFI2B0 | 200 | | |
| | 0.13 | 12.0 x 22.0 x 26.0 | 7.8 | 41830KIP2T0 | 41830KIM2T0 | 150 | 41830KFI2B0 | 200 | | |
| | 0.18 | 12.5 x 22.5 x 26.5 | 11.0 | 42230KIP2T0 | 42230KIM2T0 | 140 | 42230KFI2B0 | 200 | | |
| | 0.22 | 12.0 ^ 22.0 X 20.0 | | 42730KIP2T0 | 42730KIM2T0 | 140 | 42730KFI2B0 | 200 | | |
| | 0.27 | 15.5 x 26.5 x 26.5 | 14.0 | 43330KIP2T0 | 43330KIM2T0 | 110 | 43330KFI2B0 | 275 | | |
| | 0.39 | 18.0 x 29.5 x 26.5 | 20.5 | 43930KIP2T0 | 43930KIM2T0 | 90 | 43930KFI2B0 | 250 | | |
| | 0.08 | 10.0 / 23.0 / 20.0 | 20.0 | +0300KIF Z I Ü | TOTOUNIVIZ I U | 90 | +0300KI 12DU | 230 | | 1 |

- SPQ = Standard Packing Quantity
- (1) Reel diameter = 356 mm is available on request
- $^{(2)}$ H = in-tape height; P_0 = sprocket hole distance; for detailed specifications refer to "Packaging Information"
- (3) Weight for short lead product only
- (4) For tolerances see chapter "Space Requirements for Printed-Circuit Board Applications and Dimension Tolerances"



| ELE | CTRIC | AL DATA AND | ORDEF | RING INFORM | MATION | | | | | |
|-------------------------|----------------|--------------------|----------------------------|-------------------------------------|-------------------------------------|--------|--------------------------------------|------------|--|------|
| | | | | | CATALOG NU | MBER | F340Y2 AND P | ACKAG | ing | |
| | DIMENSIONS (4) | | | | LOOSE IN | вох | | | TAPED REEL | |
| U _{RAC} (V) | CAP. (µF) | wxhxl | MASS (g) ⁽³⁾ | SHO | ORT LEADS | | LONG LEADS | | (500 mm) ⁽¹⁾ | (2) |
| (•) | (μι) | (mm) | (9) | l _t = 3.5 mm ± 0.3 mm | l _t = 5.0 mm ± 1.0 mm | SPQ | l _t = 25.0 mm ± 2.0 mm | SPQ | H = 18.5 mm; P ₀ = 12.7 mm | SPQ |
| | | | PITCH = 2 | 27.5 mm ± 0.4 mr | n; d _t = 0.80 mm ± | 0.08 m | m; C-TOL. = ± 10 |) % | | |
| | 0.10 | 9.0 x 19.0 x 31.0 | 5.5 | 41030KKP2T0 | 41030KKM2T0 | 100 | 41030KKI2B0 | 150 | | |
| | 0.12 | 9.0 X 19.0 X 31.0 | 5.5 | 41230KKP2T0 | 41230KKM2T0 | 100 | 41230KKI2B0 | 150 | | |
| | 0.15 | 11 0 × 01 0 × 01 0 | 7.4 | 41530KKP2T0 | 41530KKM2T0 | 100 | 41530KKI2B0 | 125 | | |
| | 0.18 | 11.0 x 21.0 x 31.0 | 7.4 | 41830KKP2T0 | 41830KKM2T0 | 100 | 41830KKI2B0 | 125 | | |
| | 0.22 | 13.0 x 23.0 x 31.0 | 9.2 | 42230KKP2T0 | 42230KKM2T0 | 100 | 42230KKI2B0 | 125 | | |
| | 0.27 | 15.0 x 25.0 x 31.0 | 12.3 | 42730KKP2T0 | 42730KKM2T0 | 100 | 42730KKI2B0 | 125 | = | - |
| | 0.33 | 10.0 × 00.0 × 01.0 | 16.1 | 43330KKP2T0 | 43330KKM2T0 | 100 | 43330KKI2B0 | 100 | | |
| | 0.39 | 18.0 x 28.0 x 31.0 | 16.1 | 43930KKP2T0 | 43930KKM2T0 | 100 | 43930KKI2B0 | 100 | | |
| | 0.47 | 01.001.001.0 | 00.0 | 44730KKP2T0 | 44730KKM2T0 | | 44730KKI2B0 | 7.5 | | |
| | 0.56 | 21.0 x 31.0 x 31.0 | 20.3 | 45630KKP2T0 | 45630KKM2T0 | 50 | 45630KKI2B0 | 75 | | |
| | 0.68 | 20.0 x 35.0 x 31.0 | 17.5 | 46830KKP2T0 | 46830KKM2T0 | 50 | 46830KKI2B0 | 75 | | |
| | | | PITCH = | 37.5 mm ± 0.5 m | m; d _t = 1.0 mm ± | 0.1 mn | n; C-TOL. = ± 10 | % | | |
| | 0.47 | 14.5 x 24.5 x 41.5 | 14.8 | 44730KPP2T0 | 44730KPM2T0 | 80 | 44730KPI2T0 | 80 | | |
| | 0.56 | 16.0 x 28.5 x 41.5 | 19.5 | 45630KPP2T0 | 45630KPM2T0 | 70 | 45630KPI2T0 | 70 | | |
| | 0.68 | 16.0 X 26.5 X 41.5 | 18.5 | 46830KPP2T0 | 46830KPM2T0 | 70 | 46830KPI2T0 | 70 | - | - |
| | 0.82 | 18.0 x 32.5 x 41.5 | 26 | 48230KPP2T0 | 48230KPM2T0 | 60 | 48230KPI2T0 | 60 | | |
| | 1.0 | 18.5 x 35.5 x 43.0 | 30 | 51030KPP2T0 | 51030KPM2T0 | 105 | 51030KPI2T0 | 105 | | |
| | | | PITCH = | 15.0 mm ± 0.4 m | m; d _t = 0.60 mm ± | 0.06 m | m; C-TOL. = ± 5 | % | | |
| | 0.010 | | | 31030JFP2B0 | 31030JFM2B0 | | 31030JFI2B0 | | 31030JF02W0 | |
| | 0.012 | 5.0 x 11.0 x 17.5 | 1.0 | 31230JFP2B0 | 31230JFM2B0 | 1250 | 31230JFI2B0 | 1000 | 31230JF02W0 | 1100 |
| | 0.015 | | | 31530JFP2B0 | 31530JFM2B0 | | 31530JFI2B0 | | 31530JF02W0 | |
| | 0.018 | 0.0 10.0 17.5 | 4.4 | 31830JFP2B0 | 31830JFM2B0 | 1000 | 31830JFI2B0 | | 31830JF02W0 | 900 |
| 305 | 0.022 | 6.0 x 12.0 x 17.5 | 1.4 | 32230JFP2B0 | 32230JFM2B0 | 1000 | 32230JFI2B0 | | 32230JF02W0 | 900 |
| | | | PITCH = | 15.0 mm ± 0.4 m | m; d _t = 0.80 mm ± | 0.08 m | nm; C-TOL. = ± 5 | % | | |
| | 0.027 | 7.0 x 13.5 x 17.5 | 1.8 | 32730JFP2B0 | 32730JFM2B0 | 750 | 32730JFI2B0 | | 32730JF02W0 | 800 |
| | 0.033 | 7.0 X 13.3 X 17.3 | 1.0 | 33330JFP2B0 | 33330JFM2B0 | 730 | 33330JFI2B0 | 500 | 33330JF02W0 | 800 |
| | 0.039 | 0.5 × 15 0 × 17 5 | 2.4 | 33930JFP2B0 | 33930JFM2B0 | 750 | 33930JFI2B0 | 300 | 33930JF02W0 | GE O |
| | 0.047 | 8.5 x 15.0 x 17.5 | 2.4 | 34730JFP2B0 | 34730JFM2B0 | 750 | 34730JFI2B0 | | 34730JF02W0 | 650 |
| | 0.056 | 10.0 x 16.5 x 17.5 | 3.0 | 35630JFP2B0 | 35630JFM2B0 | 500 | 35630JFI2B0 | 450 | 35630JF02W0 | 600 |
| | 0.068 | 10.0 X 16.5 X 17.5 | 3.0 | 36830JFP2B0 | 36830JFM2B0 | 300 | 36830JFI2B0 | 430 | 36830JF02W0 | 000 |
| | 0.082 | 11.0 x 18.5 x 18.0 | 5.5 | 38230JFP2B0 | 38230JFM2B0 | 225 | 38230JFI2B0 | 350 | - | - |
| | | | PITCH = | | $m; d_t = 0.80 mm \pm$ | 0.08 m | | % | | |
| | 0.033 | 6.0 x 15.5 x 26.0 | 2.4 | 33330JIP2T0 | 33330JIM2T0 | 300 | 33330JII2B0 | 250 | | |
| | 0.039 | 0.0 X 10.0 X 20.0 | 2.7 | 33930JIP2T0 | 33930JIM2T0 | 000 | 33930JII2B0 | 200 | | |
| | 0.047 | 7.0 x 16.5 x 26.0 | 2.9 | 34730JIP2T0 | 34730JIM2T0 | 200 | 34730JII2B0 | 250 | | |
| | 0.056 | 7.0 X 10.0 X 20.0 | 2.0 | 35630JIP2T0 | 35630JIM2T0 | 200 | 35630JII2B0 | 200 | | |
| | 0.068 | 8.5 x 18.0 x 26.0 | 3.8 | 36830JIP2T0 | 36830JIM2T0 | 200 | 36830JII2B0 | 250 | | |
| | 0.082 | 0.0 X 10.0 X 20.0 | 0.0 | 38230JIP2T0 | 38230JIM2T0 | 200 | 38230JII2B0 | 200 | | |
| | 0.10 | 10.0 x 19.5 x 26.0 | 6.8 | 41030JIP2T0 | 41030JIM2T0 | 200 | 41030JII2B0 | 200 | _ | _ |
| | 0.12 | 10.0 % 10.0 % 20.0 | 0.0 | 41230JIP2T0 | 41230JIM2T0 | 200 | 41230JII2B0 | 200 | | |
| | 0.15 | 12.0 x 22.0 x 26.0 | 7.8 | 41530JIP2T0 | 41530JIM2T0 | 150 | 41530JII2B0 | 200 | | |
| | 0.18 | 12.0 X 22.0 X 20.0 | 7.0 | 41830JIP2T0 | 41830JIM2T0 | 1.00 | 41830JII2B0 | 200 | | |
| | 0.22 | 12.5 x 22.5 x 26.5 | 8.4 | 42230JIP2T0 | 42230JIM2T0 | 140 | 42230JII2B0 | 200 | | |
| | 0.27 | 15.5 x 26.5 x 26.5 | 14 | 42730JIP2T0 | 42730JIM2T0 | 110 | 42730JII2B0 | 275 | | |
| | 0.33 | | | 43330JIP2T0 | 43330JIM2T0 | | 43330JII2B0 | | | |
| | 0.39 | 18.0 x 29.5 x 26.5 | 20.5 | 43930JIP2T0 | 43930JIM2T0 | 90 | 43930JII2B0 | 250 | | |

- SPQ = Standard Packing Quantity
 (1) Reel diameter = 356 mm is available on request
- (2) H = in-tape height; P₀ = sprocket hole distance; for detailed specifications refer to "Packaging Information"
- (3) Weight for short lead product only
- (4) For tolerances see chapter "Space Requirements for Printed-Circuit Board Applications and Dimension Tolerances"



Vishay BCcomponents

| ELE | LECTRICAL DATA AND ORDERING INFORMATION | | | | | | | | | |
|------------------|---|--------------------|--------------------|-------------------------------------|-------------------------------------|--------|--------------------------------------|------------|--|-----|
| | CATALOG NUMBER F340Y2 AND PACKAGING | | | | | | | | | |
| U _{RAC} | CAP. | DIMENSIONS (4) | MASS | | LOOSE IN | вох | | TAPED REEL | | _ |
| (V) | (μ F) | w x h x l (mm) | (g) ⁽³⁾ | SHO | ORT LEADS | | LONG LEAD | os | (500 mm) ⁽¹⁾⁽ | 2) |
| | | (11111) | | l _t = 3.5 mm ± 0.3 mm | l _t = 5.0 mm ± 1.0 mm | SPQ | l _t = 25.0 mm ± 2.0 mm | SPQ | H = 18.5 mm; P ₀ = 12.7 mm | SPQ |
| | | | PITCH = | 27.5 mm ± 0.4 m | m; d _t = 0.80 mm ± | 0.08 m | m; C-TOL. = ± 5 | % | | |
| | 0.10 | 9.0 x 19.0 x 31.0 | 5.5 | 41030JKP2T0 | 41030JKM2T0 | 100 | 41030JKI2B0 | 150 | | |
| | 0.12 | 9.0 % 19.0 % 31.0 | 5.5 | 41230JKP2T0 | 41230JKM2T0 | 100 | 41230JKI2B0 | 130 | | |
| | 0.15 | 11.0 x 21.0 x 31.0 | 7.4 | 41530JKP2T0 | 41530JKM2T0 | 100 | 41530JKI2B0 | 125 | | |
| | 0.18 | 11.0 X 21.0 X 31.0 | 7.4 | 41830JKP2T0 | 41830JKM2T0 | 100 | 41830JKI2B0 | | | |
| 305 | 0.22 | 13.0 x 23.0 x 31.0 | 9.2 | 42230JKP2T0 | 42230JKM2T0 | 100 | 42230JKI2B0 | 125 | | |
| 303 | 0.27 | 15.0 x 25.0 x 31.0 | 12.3 | 42730JKP2T0 | 42730JKM2T0 | 100 | 42730JKI2B0 | 125 | - | - |
| | 0.33 | 18.0 x 28.0 x 31.0 | 16.1 | 43330JKP2T0 | 43330JKM2T0 | 100 | 43330JKI2B0 | 100 | | |
| | 0.39 | 10.0 % 20.0 % 01.0 | 10.1 | 43930JKP2T0 | 43930JKM2T0 | 100 | 43930JKI2B0 | 100 | | |
| | 0.47 | 21.0 x 31.0 x 31.0 | 20.3 | 44730JKP2T0 | 44730JKM2T0 | 50 - | 44730JKI2B0 | 75 | | |
| | 0.56 | 21.0 x 01.0 x 01.0 | 20.0 | 45630JKP2T0 | 45630JKM2T0 | | 45630JKI2B0 | 7.5 | | |
| | 0.68 | 20.0 x 35.0 x 31.0 | 17.5 | 46830JKP2T0 | 46830JKM2T0 | 50 | 46830JKI2B0 | 75 | | |

Notes

- SPQ = Standard Packing Quantity
- (1) Reel diameter = 356 mm is available on request
- $^{(2)}$ H = in-tape height; P_0 = sprocket hole distance; for detailed specifications refer to "Packaging Information"
- (3) Weight for short lead product only
- (4) For tolerances see chapter "Space Requirements for Printed-Circuit Board Applications and Dimension Tolerances"

| APPROVALS | | | | | | | |
|--|---------------------|--------------|--------------------|--------------------------|--|--|--|
| SAFETY APPROVALS Y2 | VOLTAGE | VALUE | FILE NUMBERS | LINK | | | |
| EN 60384-14 (ENEC) (= IEC 60384-14 ed-4 (2013)) | 305 V _{AC} | 1 nF to 1 μF | ENEC16/FI/19/10007 | www.vishay.com/doc?28253 | | | |
| UL 60384-14 (2 nd edition) | 305 V _{AC} | 1 nF to 1 μF | E354331 | www.vishay.com/doc?28256 | | | |
| CSA-E60384-1:14 (3 rd edition) | 305 V _{AC} | 1 nF to 1 μF | E354331 | www.vishay.com/doc?28256 | | | |
| CQC | 305 V _{AC} | 1 nF to 1 μF | L-15001128762 | www.vishay.com/doc?28251 | | | |
| ode | COO VAC | ττιι το τ μι | F-15001128766 | www.vishay.com/doc?28252 | | | |
| CB-test certificate | 305 V _{AC} | 1 nF to 1 μF | FI-39833 | www.vishay.com/doc?28254 | | | |

The ENEC-approval together with the CB-certificate replace all national marks of the following countries (they have already signed the ENEC-agreement): Austria; Belgium; Czech Republic; Denmark; Finland; France; Germany; Greece; Hungary; Ireland; Italy; Luxembourg; Netherlands; Norway; Portugal; Slovenian; Spain; Sweden, Switzerland, and United Kingdom.







MOUNTING

Normal Use

The capacitors are designed for mounting on printed-circuit boards. The capacitors packed in bandoliers are designed for mounting in printed-circuit boards by means of automatic insertion machines.

For detailed tape specifications refer to packaging information www.vishay.com/docs?28139

Specific Method of Mounting to Withstand Vibration and Shock

In order to withstand vibration and shock tests, it must be ensured that the stand-off pips are in good contact with the printed-circuit board:

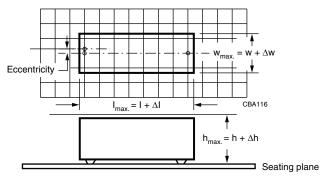
- For original pitch ≤ 15 mm the capacitors shall be mechanically fixed by the leads
- · For larger pitches the capacitors shall be mounted in the same way and the body clamped

Space Requirements for Printed-Circuit Board Applications and Dimension Tolerances

For the maximum product dimensions and maximum space requirements for length (I_{max.}), width (w_{max.}) and height (h_{max.}) following tolerances must be taken in account in the envelopment of the components as shown in the drawings below.

- For products with pitch \leq 15 mm, $\Delta w = \Delta l = 0.3$ mm, and $\Delta h = 0.1$ mm
- For products with 15 mm < pitch \leq 27.5 mm, $\Delta w = \Delta l = 0.5$ mm, and $\Delta h = 0.1$ mm
- For products with pitch = 37.5 mm, $\Delta w = \Delta l = 0.7$ mm, and $\Delta h = 0.5$ mm

Eccentricity defined as in drawing. The maximum eccentricity is smaller than or equal to the lead diameter of the product concerned.



For the minimum product dimensions for length (I_{min.}), width (w_{min.}), and height (h_{min.}) following tolerances of the components are valid:

 $I_{min.} = I - \Delta I$, $w_{min.} = w - \Delta w$, and $h_{min.} = h - \Delta h$ following

- For products with pitch \leq 10 mm, $\Delta l = 0.3$ mm, and $\Delta w = \Delta h = 0.3$ mm
- For products with pitch = 15 mm, $\Delta l = 0.5$ mm, and $\Delta w = \Delta h = 0.5$ mm
- For products with 15 mm < pitch \leq 27.5 mm, $\Delta l = 1.0$ mm, and $\Delta w = \Delta h = 0.5$ mm
- For products with pitch = 37.5 mm, $\Delta l = 1.0$ mm, and $\Delta w = \Delta h = 1.0$ mm

SOLDERING CONDITIONS

For general soldering conditions and wave soldering profile we refer to the document "Soldering Guidelines for Film Capacitors": www.vishay.com/doc?28171

STORAGE TEMPERATURE

 T_{sta} = -25 °C to +35 °C with RH maximum 75 % without condensation

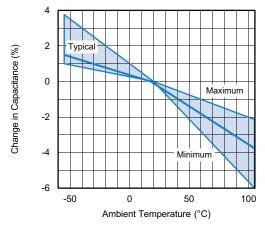
RATINGS AND CHARACTERISTICS REFERENCE CONDITIONS

Unless otherwise specified, all electrical values apply to an ambient temperature of 23 °C \pm 1 °C, an atmospheric pressure of 86 kPa to 106 kPa and a relative humidity of 50 % \pm 2 %.

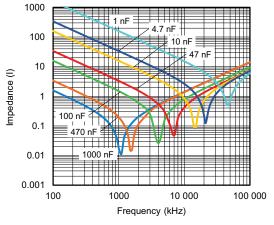
For reference testing, a conditioning period shall be applied over 96 h \pm 4 h by heating the products in a circulating air oven at the rated temperature and a relative humidity not exceeding 20 %.



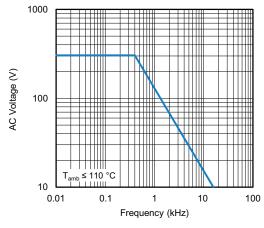
CHARACTERISTICS



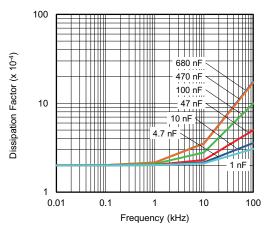
Capacitance as a function of ambient temperature (typical curve)



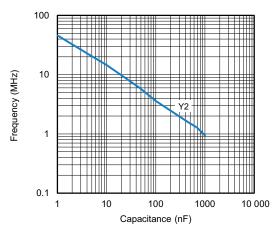
Impedance as a function of frequency (typical curve)



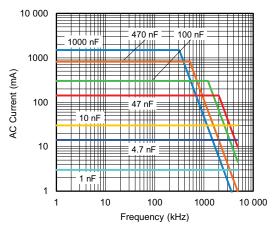
Max. RMS voltage as a function of frequency



Tangent of loss angle as a function of frequency (typical curve)

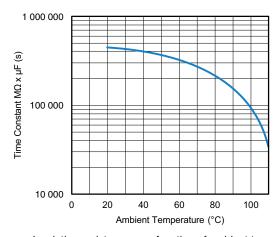


Resonant frequency as a function of capacitance (typical curve)



Max. RMS current as a function of frequency





Insulation resistance as a function of ambient temperature (typical curve)

APPLICATION NOTES

- For Y2 electromagnetic interference suppression in standard line bypass applications (50 Hz / 60 Hz) with a maximum of 305 V_{AC} rated voltage including fluctuation of the mains. It is recommended to use these components in a mains with maximum nominal voltage of 240 V_{AC}. Higher continuous applied voltages will shorten the life time
- For series impedance applications we refer to the application note: www.vishav.com/doc?28153
- To ensure withstanding high humidity requirements in the application it is recommended not to damage the epoxy adhesion at the leads. Therefore the leads may not be damaged or bent before soldering
- For capacitors connected in parallel, normally the proof voltage and possibly the rated voltage must be reduced. For information depending of the capacitance value and the number of parallel connections contact: rfi@vishay.com
- These capacitors are not intended for continuous pulse applications. For these situations, capacitors of the AC and pulse programs must be used
- The maximum ambient temperature must not exceed 105 °C
- Rated voltage pulse slope:
 if the pulse voltage is lower than the rated voltage, the values of the specific reference data can be multiplied by 420 V_{DC} and divided by the applied voltage

INSPECTION REQUIREMENTS

General Notes

Sub-clause numbers of tests and performance requirements refer to the "Sectional Specification, Publication IEC 60384-14 ed-3 and Specific Reference Data".

| INSPECTION REQUIREMENTS | | |
|----------------------------------|--|---|
| SUB-CLAUSE NUMBER AND TEST | CONDITIONS | PERFORMANCE REQUIREMENTS |
| SUB-GROUP C1A PART OF SAMPLE OF | SUB-GROUP C1 | |
| 4.1 Dimensions (detail) | | As specified in chapters "General Data" of this specification |
| Initial measurements | Capacitance Tangent of loss angle: for C ≤ 1 µF at 10 kHz | |
| 4.3 Robustness of terminations | Tensile: load 10 N; 10 s Bending: load 5 N; 4 x 90° | |
| 4.4 Resistance to soldering heat | No pre-drying Method: 1A Solder bath: 280 °C ± 5 °C Duration: 10 s | |



| INSPECTION REQUIREMENTS SUB-CLAUSE NUMBER AND TEST | CONDITIONS | PERFORMANCE REQUIREMENTS |
|--|---|---|
| SUB-GROUP C1A PART OF SAMPLE OF | | PERFORMANCE REQUIREMENTS |
| 4.19 Component solvent | Isopropylalcohol at room temperature | |
| resistance | Method: 2 | |
| | Immersion time: 5 min ± 0.5 min | |
| | Recovery time: min. 1 h, max. 2 h | |
| 4.4.2 Final measurements | Visual examination | No visible damage |
| | | Legible marking |
| | 0 | 1.0/01 4.5 0/ 4.5 1/4 4.5 1/4 4.5 1/4 4.5 1/4 1/4 1/4 1/4 1/4 1/4 1/4 1/4 1/4 1/4 |
| | Capacitance | $ \Delta C/C \le 5$ % of the value measured initially |
| | Tangent of loss angle | Increase of tan δ : |
| | | ≤ 0.008 for: C ≤ 1 µF |
| | | Compared to values measured initially |
| | Insulation resistance | As specified in section "Insulation |
| | | Resistance" of this specification |
| SUB-GROUP C1B OTHER PART OF SAM | | T |
| Initial measurements | Capacitance Tangent of loss angle: | |
| | for C ≤ 1 μF at 10 kHz | |
| 4.00 Column variations of the moulting | loopyonyd oloobol et voom tempeyetiye | No visible demons |
| 4.20 Solvent resistance of the marking | Isopropyl alcohol at room temperature Method: 1 | No visible damage Legible marking |
| | Rubbing material: cotton wool | |
| | Immersion time: 5 min ± 0.5 min | |
| 4.6 Rapid change of temperature | θA = -55 °C | |
| ne maple change or temperature | $\theta B = +105 ^{\circ}C$ | |
| | 5 cycles Duration t = 30 min | |
| | Burdion (= 60 mm | |
| 4.6.1 Inspection | Visual examination | No visible damage |
| 4.7 Vibration | Mounting: see section "Mounting" of this | |
| 4.7 VIDIAUOII | specification | |
| | Procedure B4: | |
| | frequency range: 10 Hz to 55 Hz Amplitude: 0.75 mm or | |
| | Acceleration 98 m/s ² | |
| | (whichever is less severe) | |
| 4.7.0 Final inaparties | Total duration 6 h | No visible demage |
| 4.7.2 Final inspection | Visual examination | No visible damage |
| 4.9 Shock | Mounting: see section "Mounting" for more | |
| | information | |
| | Pulse shape: half sine Acceleration: 490 m/s ² | |
| | Duration of pulse: 11 ms | |
| 4005 | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | |
| 4.9.2 Final measurements | Visual examination | No visible damage |
| | Capacitance | $ \Delta C/C \le 5$ % of the value measured initially |
| | Tangent of loss angle | Increase of tan δ : |
| | | ≤ 0.008 for: C ≤ 1 μF |
| | | Compared to values measured initially |
| | Insulation resistance | As specified in section "Insulation |
| | | Resistance" of this specification |



| INSPECTION REQUIREMENT | s | |
|--|--|--|
| SUB-CLAUSE NUMBER AND TEST | CONDITIONS | PERFORMANCE REQUIREMENTS |
| SUB-GROUP C1 COMBINED SAMPLE | OF SPECIMENS OF SUB-GROUPS C1A AND C | C1B |
| 4.11 Climatic sequence | | |
| 4.11.1 Initial measurements | Capacitance Measured in 4.4.2 and 4.9.2 Tangent of loss angle: measured initially in C1A and C1B | |
| 4.11.2 Dry heat | Temperature: 105 °C | |
| 4.11.3 Damp heat cyclic Test Db First cycle | Duration: 16 h | |
| 4.11.4 Cold | Temperature: -55 °C | |
| 4.11.5 Damp heat cyclic Test Db remaining cycles | Duration: 2 h | |
| 4.11.6 Final measurements | Visual examination | No visible damage Legible marking |
| | Capacitance | $ \Delta C/C \le 5$ % of the value measured in 4.11.1. |
| | Tangent of loss angle | Increase of tan δ : ≤ 0.008 for C $\leq 1~\mu F$ Compared to values measured in 4.11.1 |
| | Voltage proof 2250 V _{DC} ; 1 min between terminations | No permanent breakdown or flash-over |
| | Insulation resistance | ≥ 50 % of values specified in section "Insulation Resistance" of this specification |
| SUB-GROUP C2 | | |
| 4.12 Damp heat steady state | 56 days, 40 °C, 90 % to 95 % RH, no load | |
| 4.12.1 Initial measurements | Capacitance Tangent of loss angle at 1 kHz | |
| 4.12.3 Final measurements | Visual examination | No visible damage Legible marking |
| | Capacitance | $ \Delta C/C \le 5$ % of the value measured in 4.12.1. |
| | Tangent of loss angle | Increase of tan δ : ≤ 0.008 for C \leq 1 μ F Compared to values measured in 4.12.1. |
| | Voltage proof 2250 V _{DC} ; 1 min between terminations | No permanent breakdown or flash-over |
| | Insulation resistance | ≥ 50 % of values specified in section "Insulation Resistance" of this specification |



| SUB-CI | AUSE NUMBER AND TEST | CONDITIONS | PERFORMANCE REQUIREMENTS |
|---------|----------------------------------|--|--|
| | ROUP C2A | JONETHORS | 1 EIN OUMANOE NEGONIEMENTO |
| | | | Г |
| 4.12A | Damp heat steady state with load | RH: 85 %, temp.: 85 °C, load: 305 V _{AC} Duration: 1000 h | |
| 4.12.1A | Initial measurements | Capacitance Tangent of loss angle: for $C \le 1 \mu F$ at 10 kHz | |
| 4.12.3A | Final measurements | Visual examination | No visible damage Legible marking |
| | | Capacitance | $ \Delta C/C $ ≤ 10 % of the value measured in 4.12.1A. |
| | | Tangent of loss angle | Increase of $\tan \delta$: ≤ 0.0240 for C $\leq 1 \mu F$ at 10 kHz Compared to values measured in 4.12.1A. |
| | | Insulation resistance | ≥ 50 % of values specified in section "Insulation Resistance" of this specification |
| SUB-GI | ROUP C3 | | |
| 4.13.1 | Initial measurements | Capacitance Tangent of loss angle: for C ≤ 1 µF at 10 kHz | |
| 4.13 | Impulse voltage | 3 successive impulses, full wave, peak voltage: Y2: 5 kV for C \leq 1 μ F Max. 24 pulses | No self healing breakdowns or flash-over |
| 4.14 | Endurance | Duration: 1000 h 1.7 x U_{RAC} at 105 °C Once in every hour the voltage is increased to 1000 V_{RMS} for 0.1 s via resistor of 47 Ω ± 5 % | |
| 4.14.7 | Final measurements | Visual examination | No visible damage Legible marking |
| | | Capacitance | $ \Delta C/C \le 10$ % compared to values measured in 4.13.1. |
| | | Tangent of loss angle | Increase of tan δ : \leq 0.008 for C \leq 1 μ F Compared to values measured in 4.13.1 |
| | | Voltage proof 2250 V _{DC} ; 1 min between terminations 2110 V _{AC} ; 1 min between terminations and case | No permanent breakdown or flash-over |
| | | Insulation resistance | ≥ 50 % of values specified in section "Insulation Resistance" of this specification |



| SUB-CLAUSE NUMBER AND TEST | CONDITIONS | PERFORMANCE REQUIREMENTS |
|---|--|---|
| SUB-GROUP C4 | | |
| 4.15 Charge and discharge | 10 000 cycles Charged to 420 V_{DC} Discharge resistance: $R = \frac{420 V_{DC}}{1.5 \times C \text{ (du/dt)}}$ | |
| 4.15.1 Initial measurements | Capacitance Tangent of loss angle: for $C \le 1 \mu F$ at 10 kHz for $C > 1 \mu F$ at 1 kHz | |
| 4.15.3 Final measurements | Capacitance | $ \Delta C/C \le 10$ % compared to values measured in 4.15.1. |
| | Tangent of loss angle | Increase of tan δ : ≤ 0.008 for: $C \leq 1 \mu\text{F}$ Compared to values measured in 4.15.1 |
| | Insulation resistance | ≥ 50 % of values specified in section "Insulation Resistance" of this specification |
| SUB-GROUP C5 | | • |
| 4.16 Radio frequency characteristic | Resonance frequency | ≥ 0.9 times the value as specified in section "Resonant Frequency" of this specification |
| SUB-GROUP C6 | | |
| 4.17 Passive flammability Class B for volume > 1750 mm ³ Class C for volume ≤ 1750 mm ³ | Bore of gas jet: \varnothing 0.5 mm Fuel: butane Test duration for actual volume V in mm³: Class B Class C 250 < V \le 500: - 10 s 500 < V \le 1750: - 20 s V > 1750: 60 s - One flame application: | After removing test flame from capacitor, the capacitor must not continue to burn for more than 10 s (class B) and more than 30 s (class C). No burning particle must drop from the sample. |
| SUB-GROUP C7 | | |
| 4.18 Active flammability | 20 cycles of 5 kV discharges on the test capacitor connected to U _{RAC} | The cheese cloth around the capacitors shall not burn with a flame. No electrical measurements are required. |



| STRESS | REVISION | CONDITION | SAMPLE SIZE | PERFORMANCE REQUIREMENTS |
|--|----------|--|----------------|--|
| High temperature exposure (storage) | D | Temp.: 105 °C; unpowered 250 h / 500 h / 1000 h | 77 | $ \Delta C/C \le 5$ % Increase of tan δ: ≤ 0.008 for C ≤ 1 μF at 10 kHz Increase of tan δ: ≤ 0.005 for C > 1 μF at 1 kHz IR > 50 % of initial specified value |
| 2. Temperature cycling | D | Total no. of cycles: 1000 cycles Lower temp.: -40 °C Upper temp: +105 °C 30 min dwell time at each temperature Transition time < 1 min | 77 | $ \Delta C/C $ ≤ 5 % Increase of tan δ: ≤ 0.008 for C ≤ 1 μF at 10 kHz IR > 50 % of initial specified value |
| 3. Moisture resistance | | No. of cycle: 10 cycles t = 24 h/cycle | 77 | $ \Delta C/C \le 5$ % Increase of tan δ: ≤ 0.008 for C ≤ 1 μF at 10 kHz IR > 50 % of initial specified value |
| 4. Biased humidity AC | D | Temp.: 40 °C; RH: 93 %; U _{RAC} 250 h / 500 h / 1000 h | 77 | $ \Delta C/C \le 10$ % Increase of tan δ: ≤ 0.008 for C ≤ 1 μF at 10 kHz IR > 50 % of initial specified value |
| 5. Operational life AC | D | Temp. = 105 °C; U _{RAC} 1000 h | 77 | $ \Delta C/C \le 10$ % Increase of tan δ : ≤ 0.008 for $C \le 1$ μF at 10 kHz IR > 50 % of initial specified value |
| 6. Terminal strength (leaded) | D | Test leaded device lead integrity only A (pull-test): 2.27 kg (10 s) - C (wire-lead bend test): 227 g (3 x 3 s) | 30 | No visual damage |
| 7. Resistance to solvents | D | MIL-STD-202 method 215. - Also aqueous chemical - OKEM clean or equivalent. Do not use banned solvents. | 5 | No visual damage Legible marking |
| 8. Mechanical shock | D | 100 g's ; 6 ms half-sine; 3.75 m/s | 30 | No visual damage |
| 9. Vibration | D | 5 g's for 20 min 12 cycles x 3 directions 10 Hz to 2000 Hz | 30 | No visual damage |
| 10. Resistance to soldering heat | D | Temp.: 280 °C; time: 10 s solder within 1.5 mm of device body | 30 | $ \Delta C/C \le 5$ % Increase of tan δ : ≤ 0.008 for $C \le 1$ μF at 10 kHz IR > 50 % of initial specified value |
| 11. Solderability | D | Leaded: method A at 235 °C, category 3 (245 °C / 3 s) | 15 | Good tinning as evidence by free flowing of the solder with wetting of terminations > 95 % |
| 12. Electrical characterization | | - | 30 | - |
| 13. Flammability | | One flame application Class B | 15 | V-0 or V-1 are acceptable. Class B or C according IEC is also acceptable |



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.